

February 2026 Billings (Express Report)

Japan-based Semiconductor Manufacturing Equipment

Note : All data is based on three month average numbers.

Mark your calendars. **The March Report SEAJ's Web site update** is scheduled on **20th April** approximately 3:40P.M.Japan Time. Up dates are subject to change.

Japanese Semiconductor Equipment Industry Posts February 2026 Billings of ¥423,103 million

Tokyo Japan, **March 24th, 2026** JAPAN-based manufacturers of semiconductor equipment posted **¥423,103 million** in billings in **February 2026**(three-month average basis) published today by SEAJ.

The billings figure is **1.0% percent down** the final **January 2026** level of **¥427,508 million** and **2.7percent up** the **2025 February** billings level of **¥412,065 million**.

The SEAJ billings are three-month moving average billings for the Japanese semiconductor equipment industry. Billings figures are in millions of Japanese ¥.

	Billings (Three-month avg.)	Month-Over-Month	Year-Over-Year
September 2025	424,590	4.6%	14.9%
October 2025	413,876	-2.5%	7.3%
November 2025	420,670	1.6%	3.7%
December 2025	423,487	0.7%	-4.5%
January 2026(final)	427,508	0.9%	2.6%
February 2026(prim)	423,103	-1.0%	2.7%

SEAJ can assume no responsibility for the accuracy of the underlying data.

The data are contained in a monthly Billings published by SEAJ that tracks billings worldwide of JAPAN-based manufacturers of equipment used to manufacture semiconductor devices, not billings of the chips themselves.

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